AOTF7T60PL Datasheet

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DiGi Electronics Part Number	AOTF7T60PL-DG
Manufacturer	Alpha & Omega Semiconductor Inc.
Manufacturer Product Number	AOTF7T60PL
Description	MOSFET N-CH 600V 7A TO220-3F
Detailed Description	N-Channel 600 V 7A (Tc) 29W (Tc) Through Hole TO-220F

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
AOTF7T60PL	Alpha & Omega Semiconductor Inc.
Series:	Product Status:
-	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
600 V	7A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
10V	1.1Ohm @ 3.5A, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
5V @ 250µA	25 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±30V	965 pF @ 100 V
FET Feature:	Power Dissipation (Max):
-	29W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
TO-220F	TO-220-3 Full Pack
Base Product Number:	
AOTF7	

Environmental & Export classification

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8541.29.0095

ALPHA & OMEGA SEMICONDUCTOR

AOTF7T60P

600V,7A N-Channel MOSFET

General Description

- Trench Power AlphaMOS-II technology
- Low $R_{DS(ON)}$
- Low Ciss and Crss
- High Current Capability
- RoHS and Halogen Free Compliant

Applications

- General Lighting for LED and CCFL
- AC/DC Power supplies for Industrial, Consumer, and Telecom

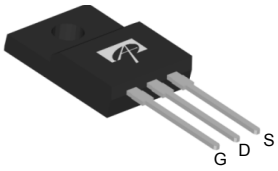
Product Summary

V_{DS} @ $T_{j,max}$	700V
I_{DM}	28A
$R_{DS(ON),max}$	< 1.1Ω
$Q_{g,typ}$	17nC
E_{oss} @ 400V	2.4µJ

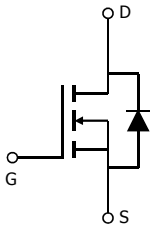
100% UIS Tested
100% R_g Tested

RoHS Compliant

Top View
TO-220F



AOTF7T60P



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOTF7T60P	TO-220F Pb Free	Tube	1000
AOTF7T60PL	TO-220F Green	Tube	1000

Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	AOTF7T60P	AOTF7T60PL	Units
Drain-Source Voltage		V_{DS}	600		V
Gate-Source Voltage		V_{GS}	±30		V
Continuous Drain Current	T_C=25°C	I_D	7*	7*	A
	T_C=100°C		5*	5*	
Pulsed Drain Current [C]		I_{DM}	28		
Avalanche Current [C] L=1mH		I_{AR}	7		A
Repetitive avalanche energy [C]		E_{AR}	25		mJ
Single pulsed avalanche energy [G]		E_{AS}	368		mJ
MOSFET dv/dt ruggedness		dv/dt	50		V/ns
Peak diode recovery dv/dt [J]			15		
Power Dissipation [B]	T_C=25°C	P_D	38	29	W
	Derate above 25°C		0.3	0.2	W/°C
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds		T_L	300		°C

Thermal Characteristics

Parameter	Symbol	AOTF7T60P	AOTF7T60PL	Units
Maximum Junction-to-Ambient [A,D]	$R_{\theta JA}$	65	65	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	3.3	4.3	°C/W

* Drain current limited by maximum junction temperature.

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Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=250µA, V_{GS}=0V, T_J=25°C	600			V
		I_D=250µA, V_{GS}=0V, T_J=150°C		700		
BV_{DSS} /ΔTJ	Breakdown Voltage Temperature Coefficient	I_D=250µA, V_{GS}=0V		0.54		V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=600V, V_{GS}=0V			1	µA
		V_{DS}=480V, T_J=125°C			10	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}=±30V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=5V, I_D=250µA	3	4.2	5	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V, I_D=3.5A		0.95	1.1	Ω
g_{FS}	Forward Transconductance	V_{DS}=40V, I_D=3.5A		5.5		S
V_{SD}	Diode Forward Voltage	I_S=1A,V_{GS}=0V		0.76	1	V
I_S	Maximum Body-Diode Continuous Current				7	A
I_{SM}	Maximum Body-Diode Pulsed Current [C]				28	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=100V, f=1MHz		965		pF
C_{oss}	Output Capacitance			36		pF
$C_{o(er)}$	Effective output capacitance, energy related [H]	V_{GS}=0V, V_{DS}=0 to 480V, f=1MHz		29		pF
$C_{o(tr)}$	Effective output capacitance, time related [I]			49		pF
C_{rss}	Reverse Transfer Capacitance	V_{GS}=0V, V_{DS}=100V, f=1MHz		6.2		pF
R_g	Gate resistance	f=1MHz		2.2		Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	V_{GS}=10V, V_{DS}=480V, I_D=7A		17	25	nC
Q_{gs}	Gate Source Charge			6.5		nC
Q_{gd}	Gate Drain Charge			5.1		nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=10V, V_{DS}=300V, I_D=7A, R_G=25Ω		30		ns
t_r	Turn-On Rise Time			42		ns
$t_{D(off)}$	Turn-Off DelayTime			34		ns
t_f	Turn-Off Fall Time			22		ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=7A,dI/dt=100A/µs,V_{DS}=100V		386		ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=7A,dI/dt=100A/µs,V_{DS}=100V		4.3		µC

A. The value of $R_{\theta JA}$ is measured with the device in a still air environment with T_A=25° C.
B. The power dissipation P_D is based on $T_{J(MAX)}$=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$=150° C, Ratings are based on low frequency and duty cycles to keep initial T_J =25° C.
D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to case $R_{\theta JC}$ and case to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300 ms pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$=150° C. The SOA curve provides a single pulse rating.
G. L=60mH, I_{AS}=3.5A, V_{DD}=150V, R_G=25Ω, Starting T_J=25° C.
H. $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.
I. $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$.
J. I_{SD}≤I_D, di/dt≤200A/µs, V_{DD}=400V, T_J≤$T_{J(MAX)}$.

ALPHA & OMEGA SEMICONDUCTOR

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

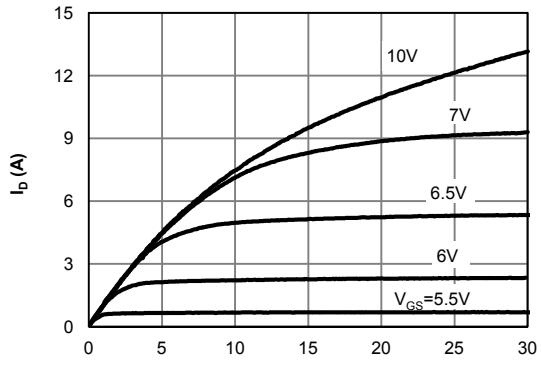

Figure 1: On-Region Characteristics

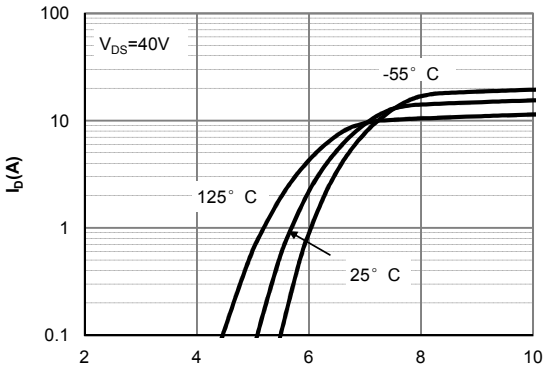

Figure 2: Transfer Characteristics

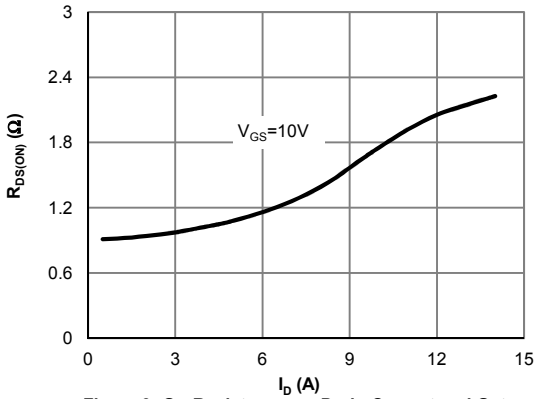

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

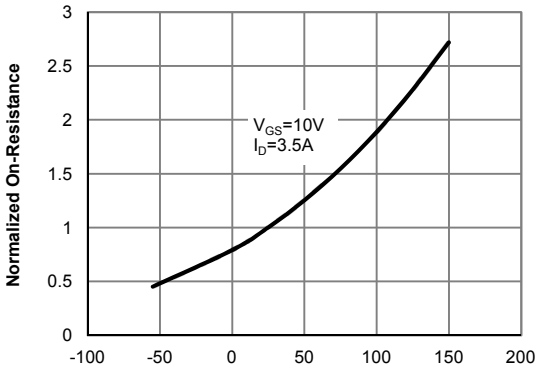

Figure 4: On-Resistance vs. Junction Temperature

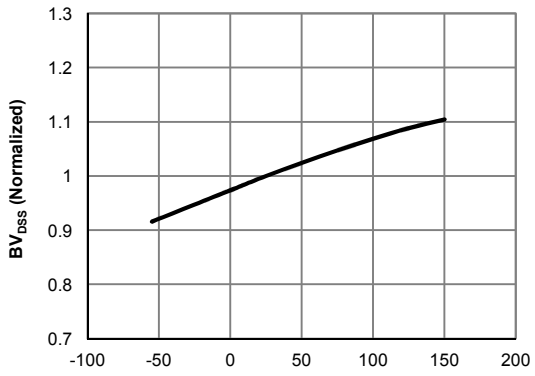

Figure 5: Break Down vs. Junction Temperature

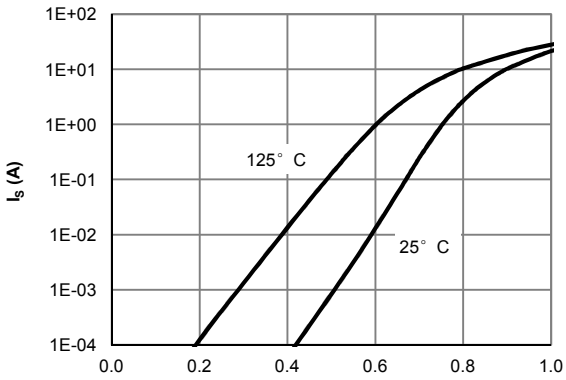

Figure 6: Body-Diode Characteristics

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

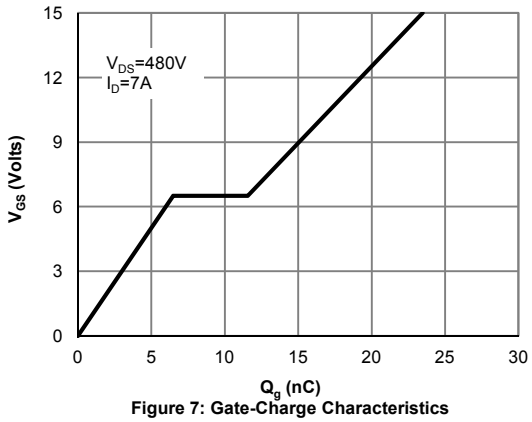

Figure 7: Gate-Charge Characteristics

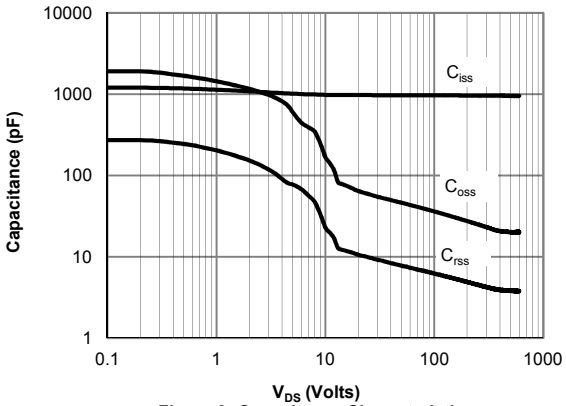

Figure 8: Capacitance Characteristics

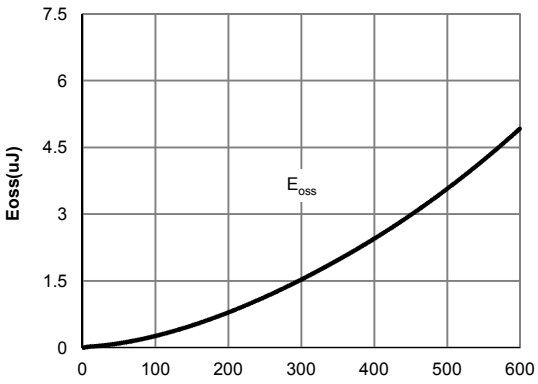

Figure 9: Coss stored Energy

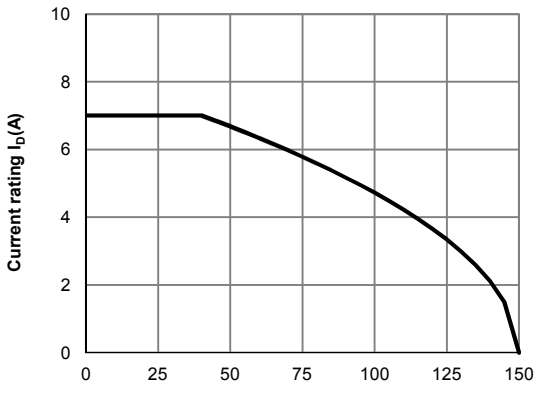

Figure 10: Current De-rating (Note F)

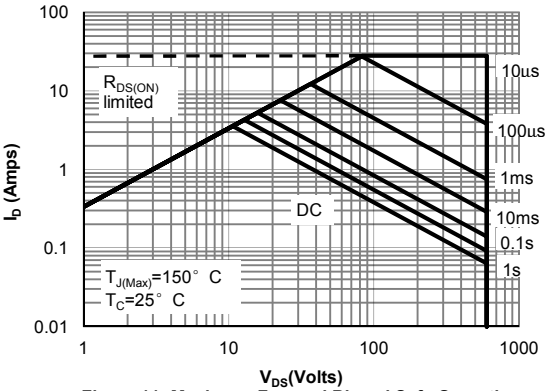

Figure 11: Maximum Forward Biased Safe Operating Area for TO-220F Pb Free (Note F)

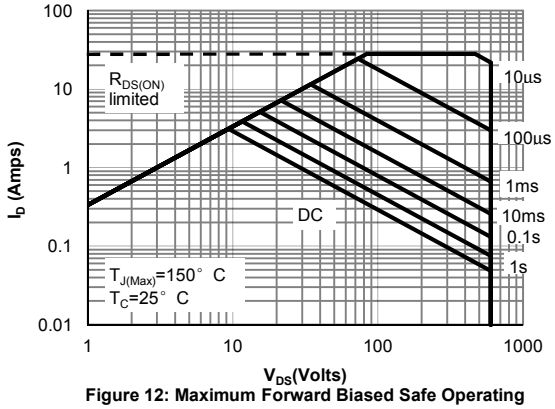

Figure 12: Maximum Forward Biased Safe Operating Area for TO-220F Green (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

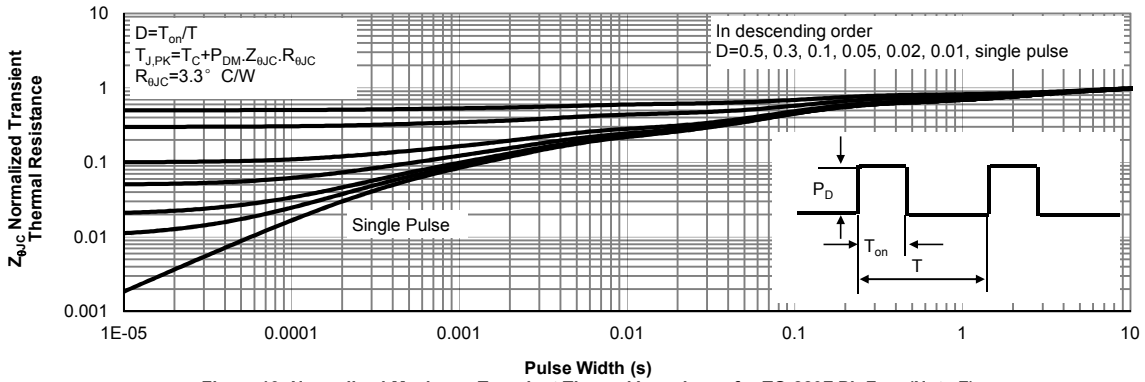

Figure 13: Normalized Maximum Transient Thermal Impedance for TO-220F Pb Free (Note F)

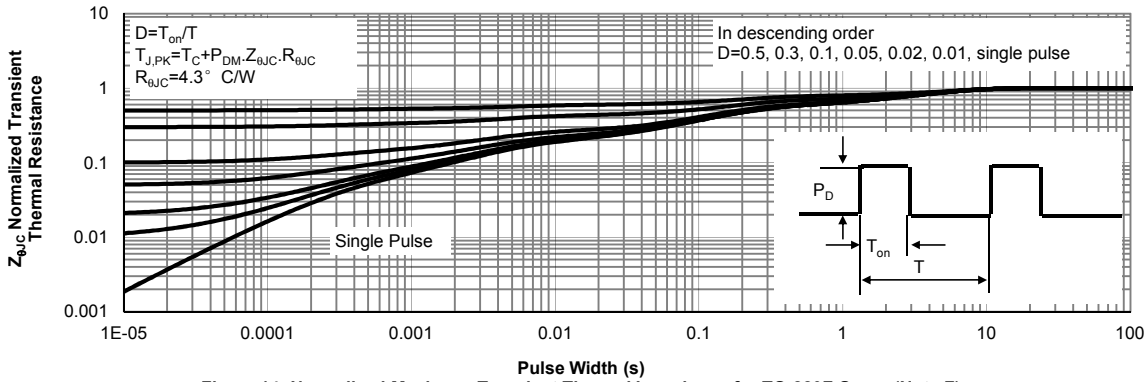

Figure 14: Normalized Maximum Transient Thermal Impedance for TO-220F Green (Note F)

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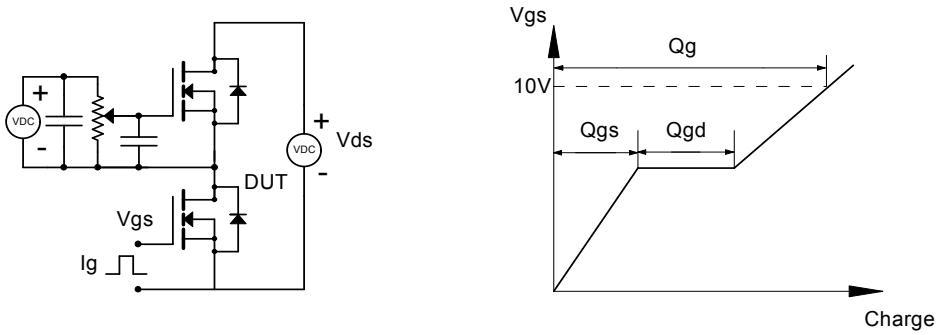
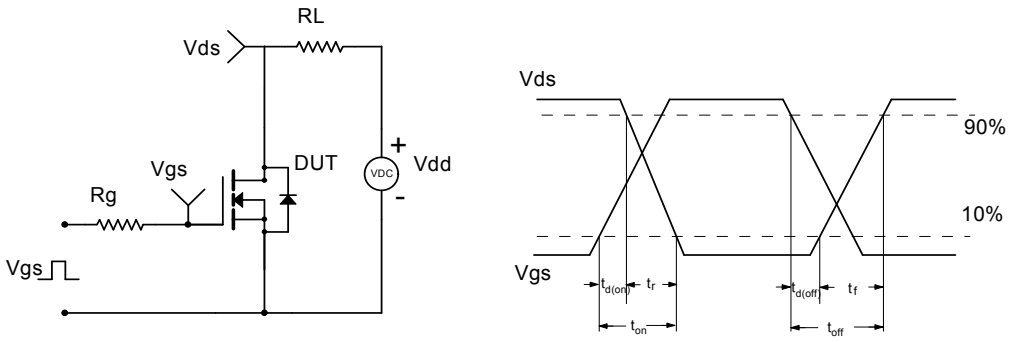
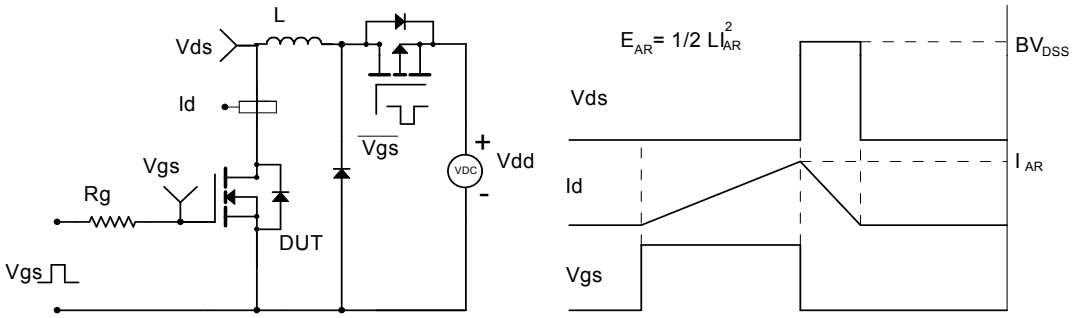
Gate Charge Test Circuit & Waveform



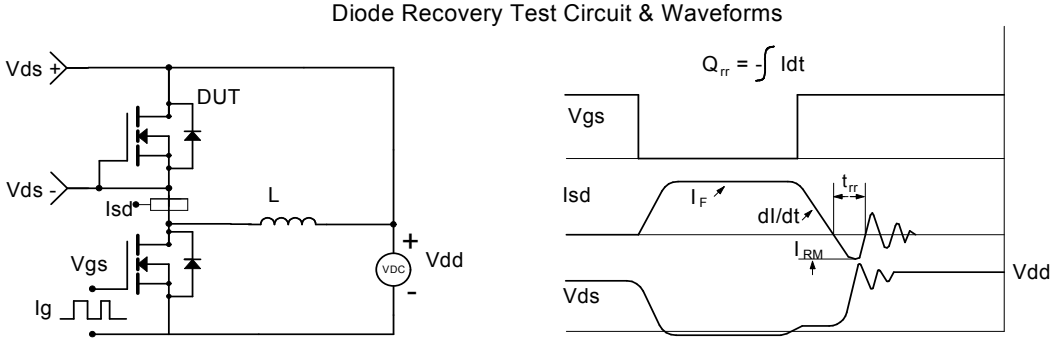
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



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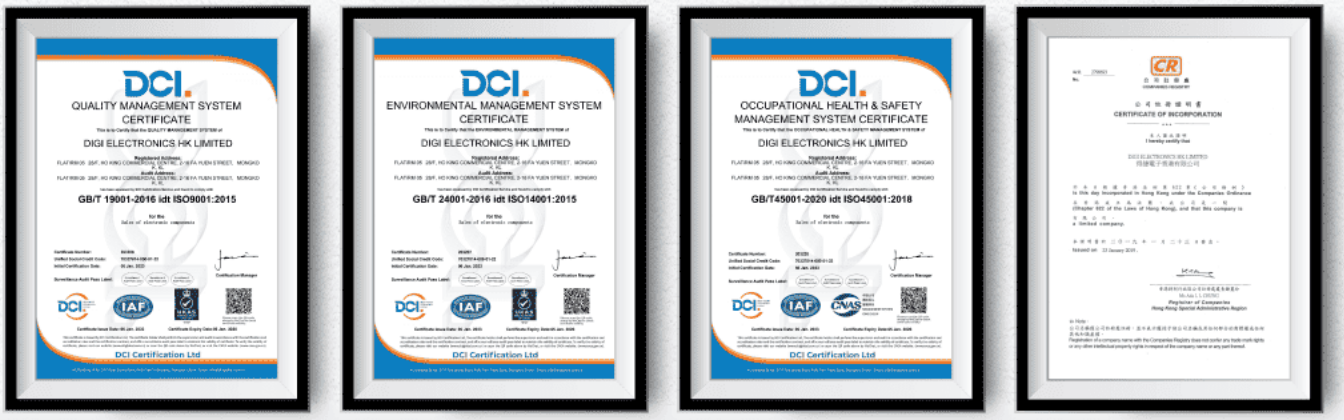

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